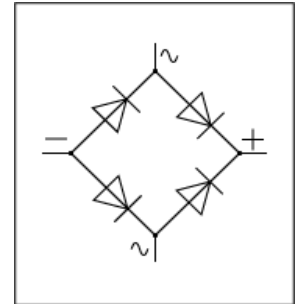


LTspice Model

Bridge Diode

ON Semiconductor

GBU6J



Model Information

Model A macro model based on general SPICE diode model
Call Name MDC_GBU6J_LT
Pin Assign 1:Out+ 2:In1 3:In2 4:Out-
File List Model Library MDC_GBU6J_LT01.lib
 Model Report MDC_GBU6J_LT.pdf (this file)

Verified Simulator Version LTspice version XVII
Note

References

The information which was used for modeling is as follow:

[Data Sheet]

- Date/Version 2001 Rev 1.2.1
- Product name GBU6J
- Company name ON Semiconductor.
- Characteristics IfVf[Temp],IrVr[Temp],capacitance,bridge

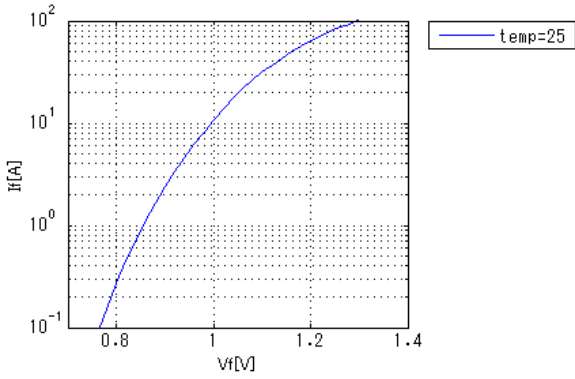
Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

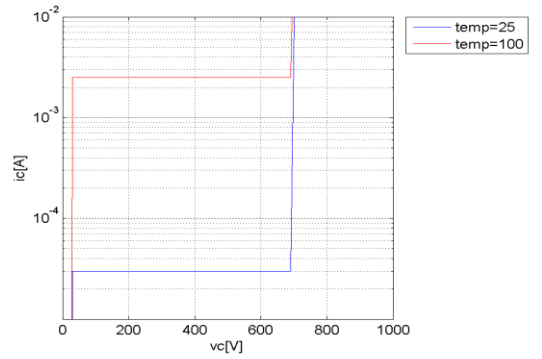
Item	Range			Unit
	Min.		Max.	
Forward Voltage	0	to	14	V
Temperature	-55	to	150	deg C

Simulation results are following.
 Explanatory notes — : simulated

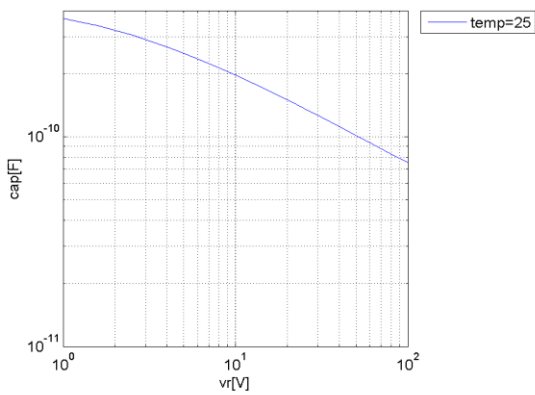
IfVf[Temp]



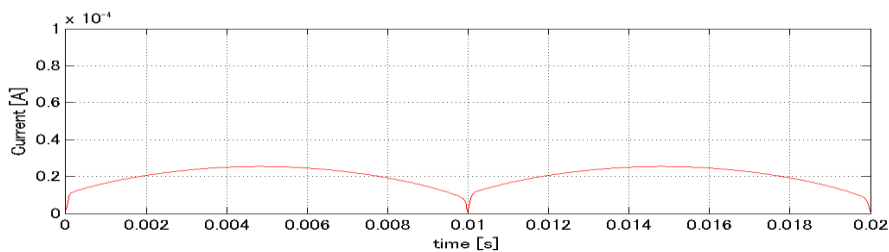
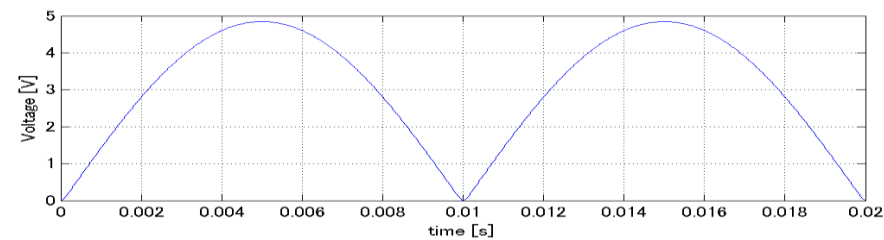
IrVr[Temp]



Capacitance (all)



bridge



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